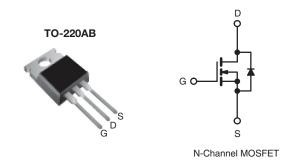


## **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	100			
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 5.0 \text{ V}$	0.077		
Q <sub>g</sub> (Max.) (nC)	64			
Q <sub>gs</sub> (nC)	9.4			
Q <sub>gd</sub> (nC)	27			
Configuration	Single			



#### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive
- R<sub>DS(on)</sub> Specified at V<sub>GS</sub> = 4 V and 5 V
- 175 °C Operating Temperature
- Fast Switching
- · Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRL540PbF		
	SiHL540-E3		
SnPb	IRL540		
	SiHL540		

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	$V_{DS}$	100	V	
Gate-Source Voltage	$V_{GS}$	± 10		
Continuous Drain Current	$V_{GS}$ at 5.0 V $T_C = 25 ^{\circ}\text{C}$	1	28	
	$V_{GS}$ at 5.0 V $T_C = 100 ^{\circ}C$	I <sub>D</sub>	20	Α
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	110		
Linear Derating Factor		1.0	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	440	mJ	
Avalanche Currenta	I <sub>AR</sub>	28	А	
Repetitive Avalanche Energy <sup>a</sup>		E <sub>AR</sub>	15	mJ
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	$P_{D}$	150	W
Peak Diode Recovery dV/dtc	dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Rang	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for 10 s		300 <sup>d</sup>	
Mounting Torque	6-32 or M3 screw		10	lbf ⋅ in
	0-32 OF IVIS SCIEW		1.1	N⋅m

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 841  $\mu$ H,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 28 A (see fig. 12c).
- c.  $I_{SD} \le 28$  A,  $dI/dt \le 170$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	
Case-to-Sink, Flat, Greasd Surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.0	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		100	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I <sub>D</sub> = 1 mA		0.12	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		-	2.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 10 V		-	± 100	nA
Zero Gate Voltage Drain Current		V <sub>DS</sub> =	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V		-	25	
	I <sub>DSS</sub>	V <sub>DS</sub> = 80 V,	V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	250	μA
Dunin Course On Otata Basistana	Б	V <sub>GS</sub> = 5.0 V	I <sub>D</sub> = 17 A <sup>b</sup>	-	-	0.077	0
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.0 V	I <sub>D</sub> = 14 A <sup>b</sup>	-	-	0.11	Ω
Forward Transconductance	9 <sub>fs</sub>	$V_{DS}$	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 17 A		-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$		-	2200	-	pF
Output Capacitance	C <sub>oss</sub>			-	560	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	140	-	
Total Gate Charge	Qg			-	-	64	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 5.0 V	$V_{GS} = 5.0 \text{ V}$ $I_D = 28 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 <sup>b</sup>		-	9.4	nC
Gate-Drain Charge	$Q_{gd}$				-	27	
Turn-On Delay Time	t <sub>d(on)</sub>			-	8.5	-	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $I_D$ = 28 A, $R_g$ = 9.0 $\Omega$ , $R_D$ = 1.7 $\Omega$ , see fig. 10 <sup>b</sup>		-	170	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	35	-	
Fall Time	t <sub>f</sub>			-	80	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	- nH
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	28	Α
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	110	
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C	$T_J = 25  ^{\circ}\text{C},  I_S = 28  \text{A},  V_{GS} = 0  \text{V}^{\text{b}}$		-	2.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 28 A, dl/dt = 100 A/μs <sup>b</sup>		_	200	260	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	1.7	2.90	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	on is dor	on is dominated by L <sub>S</sub> and L <sub>D</sub> )			

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

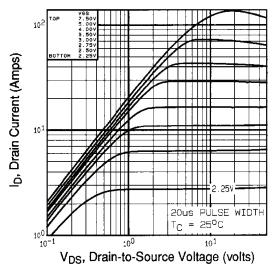


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

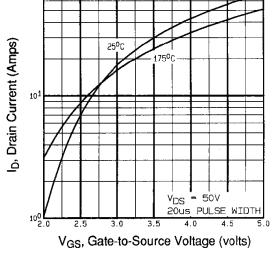


Fig. 3 - Typical Transfer Characteristics

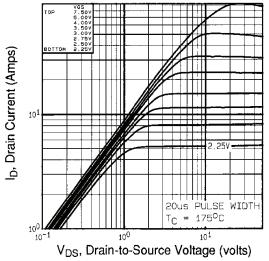


Fig. 2 - Typical Output Characteristics,  $T_C = 175$  °C

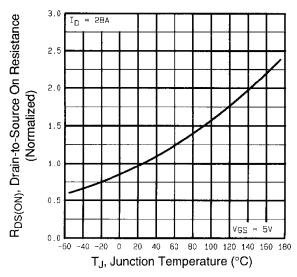


Fig. 4 - Normalized On-Resistance vs. Temperature



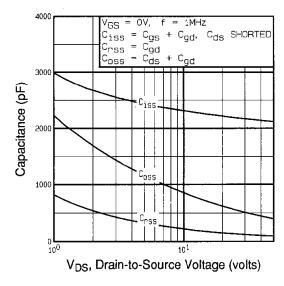


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

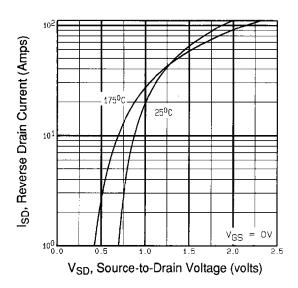


Fig. 7 - Typical Source-Drain Diode Forward Voltage

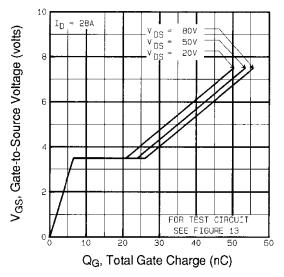


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

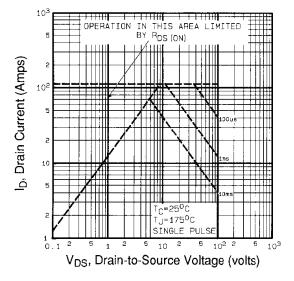
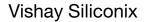


Fig. 8 - Maximum Safe Operating Area





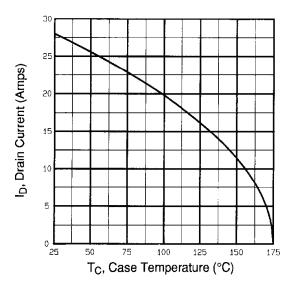


Fig. 9 - Maximum Safe Operating Area

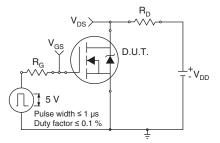


Fig. 10a - Switching Time Test Circuit

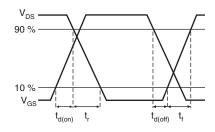


Fig. 10b - Switching Time Waveforms

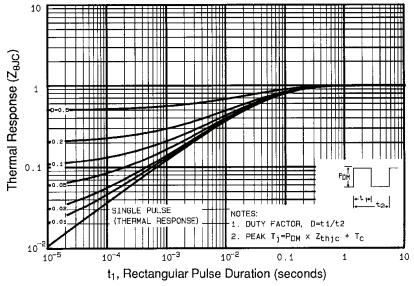
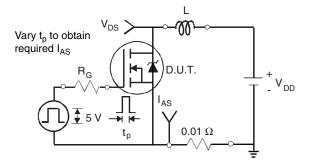


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case





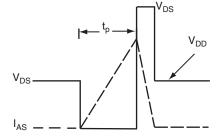


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

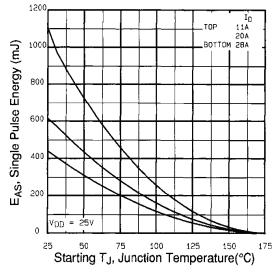


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

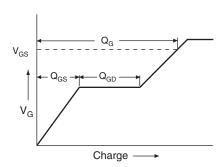


Fig. 13a - Basic Gate Charge Waveform

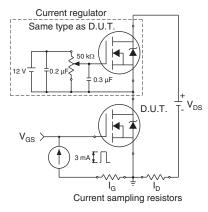
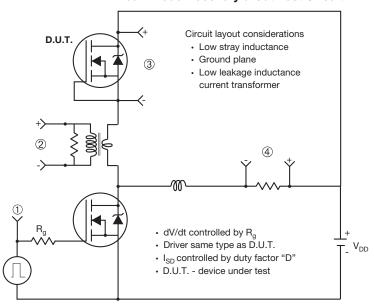


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



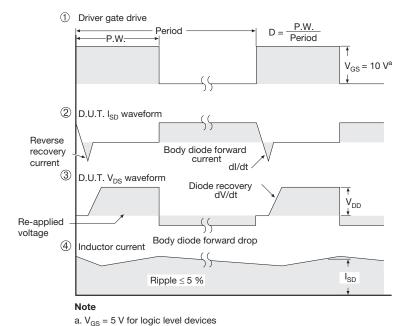


Fig. 14 - For N-Channel

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